

MOSFET

OptiMOS™ 6 Power-Transistor, 200 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- · 100% avalanche tested

Product validation

Fully qualified according to JEDEC for Industrial Applications

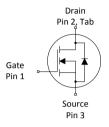
Table 1 Key performance parameters

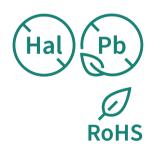
Parameter	Value	Unit
V_{DS}	200	V
R _{DS(on),max}	33.9	mΩ
I_{D}	39	А
$Q_{\rm oss}$	48	nC
Q_{G}	15.9	nC
Q _{rr} (1000A/μs)	234	nC



PG-TO220-3







Part number	Package	Marking	Related links
IPP339N20NM6	PG-TO220-3	339N20N6	-

Public

OptiMOS™ 6 Power-Transistor, 200 V IPP339N20NM6



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OptiMOS™ 6 Power-Transistor, 200 V IPP339N20NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			l lmit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
				39		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
	,		-	28		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	I _D	-		29	Α	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C	
				6.8		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	156	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	104	mJ	$I_{\rm D}$ =16 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	-	-	125	١٨/	<i>T</i> _C =25 °C	
				3.8	W	$T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Operating and storage temperature	Operating and storage temperature T_j , T_{stg} -55		-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	R_{thJC}		0.6	1.2		
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			l lmit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 52 \mu{\rm A}$	
Zero gate voltage drain current	,	-	0.1	1	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
	I _{DSS}		10	100	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	D	-	27.8	33.9	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =26 A	
Dialii-Source oii-state resistance	$R_{\mathrm{DS(on)}}$		24.2	31.8	11122	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =26 A	
Gate resistance	R_{G}	-	5.9	-	Ω	-	
Transconductance ⁶⁾	g_{fs}	6.9	14	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}$, $I_{\rm D}$ =26 A	

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
	Syllibot	Min.	Тур.	Max.	Offic	Note / Test condition
Input capacitance	C _{iss}		1200	1600		
Output capacitance 7)	C _{oss}	_	190	250	pF	V _{GS} =0 V, V _{DS} =100 V, <i>f</i> =1 MHz
Reverse transfer capacitance ⁷⁾	C _{rss}		12	21		
Turn-on delay time	$t_{\sf d(on)}$		9			
Rise time	t _r	<u> </u>	14		ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =13 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$		15]		
Fall time	t _f		8			

⁷⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Linit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Oille	Note / Test condition
Gate to source charge	Q_{gs}		8.3	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$		4.5	-	nC	
Gate to drain charge ⁹⁾	$Q_{ m gd}$		3.4	5.1	nC	
Switching charge	Q_{sw}]	7.3	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =13 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ⁹⁾	$Q_{ m g}$		15.9	24	nC	
Gate plateau voltage	$V_{ m plateau}$		6.9	-	V	
Output charge ⁹⁾	$Q_{\rm oss}$	_	48	62	nC	V _{DS} =100 V, V _{GS} =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

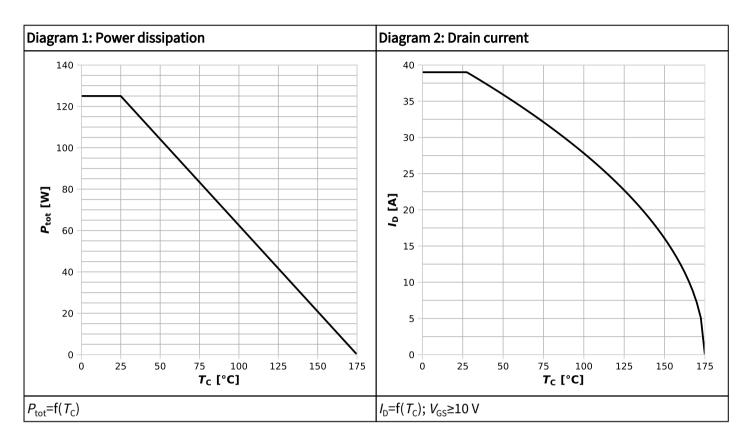
Parameter	Symbol	Values			l lmit	Note / Test condition	
	Symbol	Min.	Тур.	Max.	Oille	Note / Test condition	
Diode continuous forward current	Is				Α	T -25 °C	
Diode pulse current	I _{S,pulse}	-	150	156] ^	<i>T</i> _C =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.92	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =26 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	t _{rr}		63	-	ns	1/ 100 // / 12 A di /dk 100 A/v-	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	75	150	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =13 A, d $i_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery time	t _{rr}		26	-	ns	1/ 100 // / 12 A di /dt 1000 A/	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	243	486	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =13 A, d $i_{\rm F}$ /d t =1000 A/ μ s	

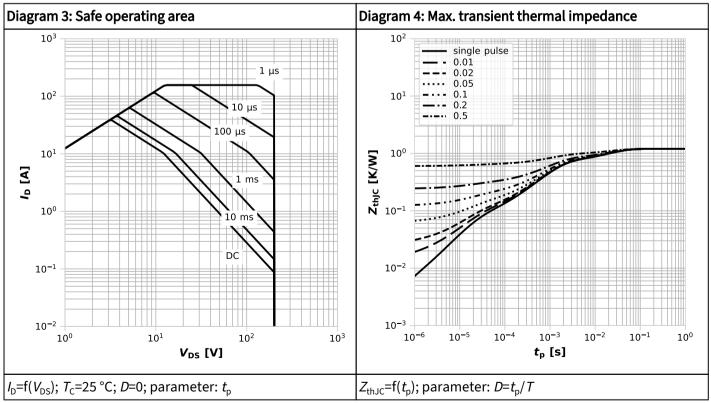
 $^{^{10)}}$ Defined by design. Not subject to production test.

⁹⁾ Defined by design. Not subject to production test.

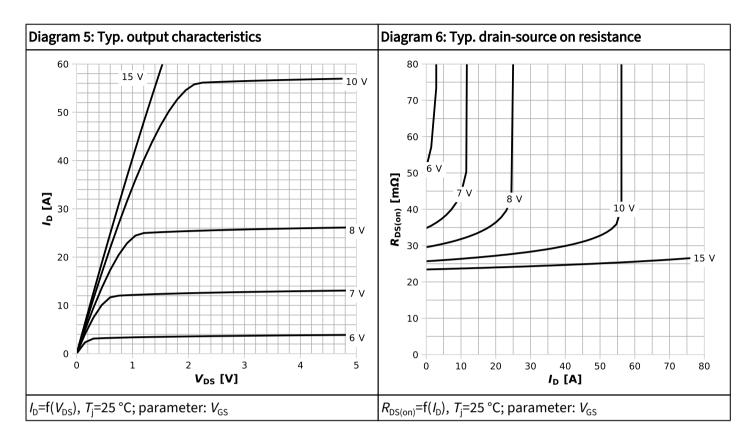


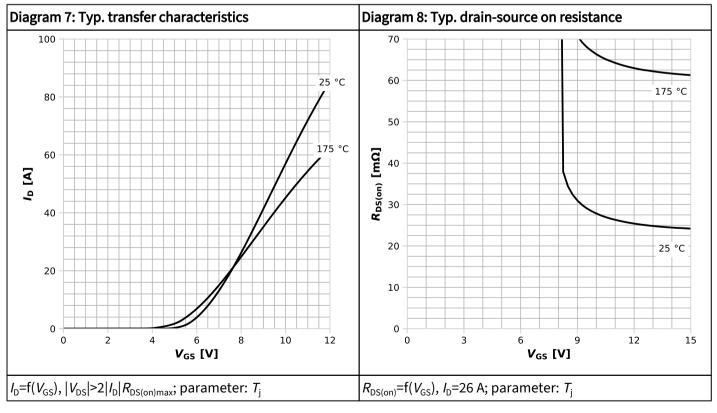
4 Electrical characteristics diagrams



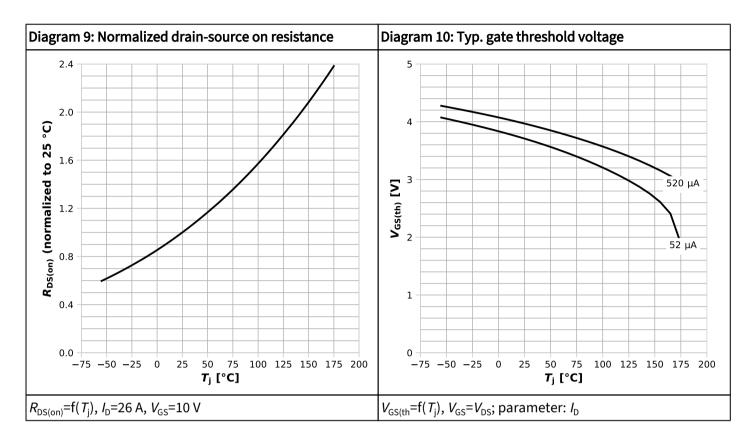


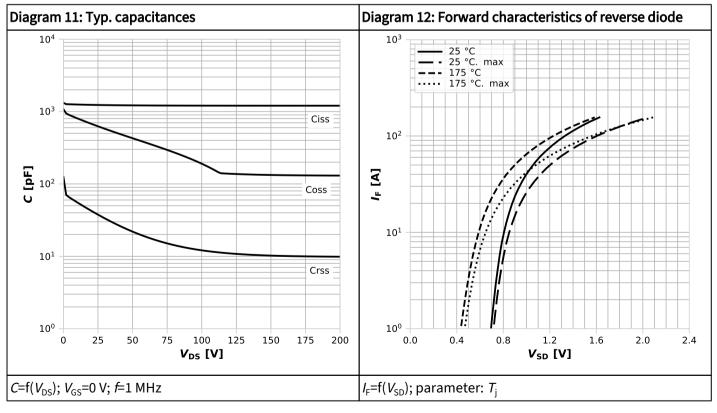




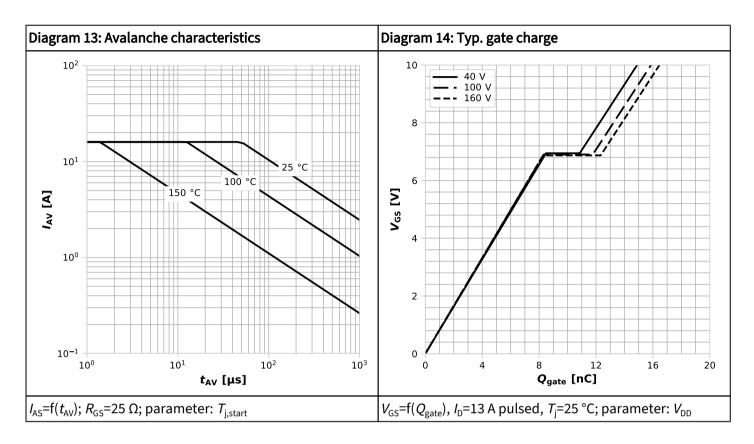


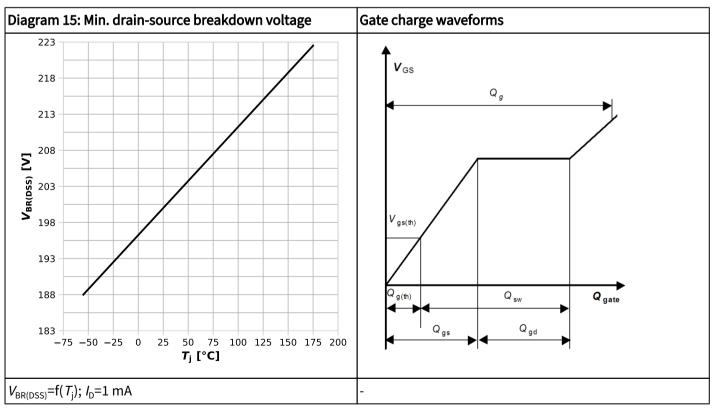














5 Package outlines

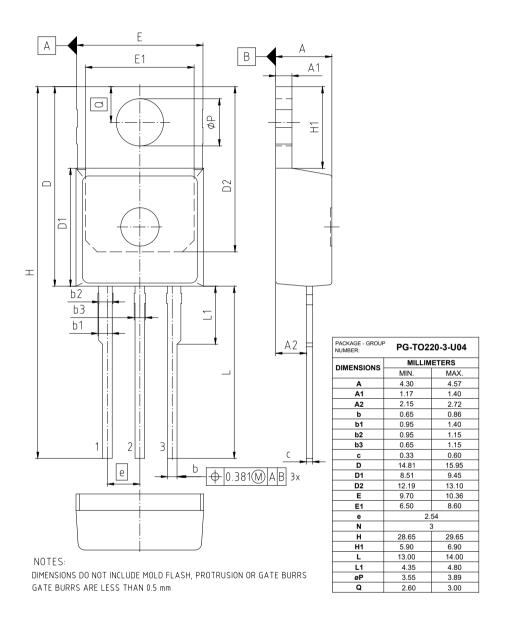


Figure 1 Outline PG-TO220-3, dimensions in mm

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Revision history

IPP339N20NM6

Revision 2025-02-26, Rev. 2.1

Previous revisions

Revision	Date	Subjects (major changes since last revision)
2.0	2023-12-07	Release of final version
2.1	2025-02-26	Update "Features"

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